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Date: February 9, 2004

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Sonia V. McVean

PATENT 50626.57

# IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Chun Ho FAN et al.

Serial No.: 10/661,480

Filing Date: September 15, 2003

For: METHOD OF FABRICATING A LEADLESS

PLASTIC CHIP CARRIER

Art Unit: 1765

Examiner: Unknown

# COMMENTARY RE INFORMATION DISCLOSURE STATEMENT

Mail Stop DD **Commissioner for Patents** P.O. Box 1450 **Alexandria, VA 22313-1450** 

Dear Sir:

In accordance with 37 CFR §1.56, and in recognition of their duty to disclose to the United States Patent and Trademark Office relevant information known to be material to patentability, Applicants herewith submit a copy of the Japanese prior art listed on the attached Information Disclosure Statement (Form PTO-1449), including an English abstract. Applicants did not submit a copy of the U.S. prior art references, as it is no longer a requirement.

The statement is not a representation that all of the information cited is necessarily effective as prior art against the application.

U.S. Application No. 10/661,480 February 9, 2004 Page 2 of 2

Applicants respectfully request that the disclosed reference be made of record in the subject application.

Respectfully submitted,

Date: February 9, 2004

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PATENT AND TRADEMARK OFFICE

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

U.S. DEPARTMENT OF COMMERCE

APPLICANTS: Chun Ho FAN et al.

FILING DATE GROUP
September 15, 2003 1765

### **U.S. PATENT DOCUMENTS**

INITIAL	DOCUMENT NO.	DATE	NAME	CLASS	SUBCL.	FILING DATE
	4,530,152	7/1985	Roche et al.	29	588	
	4,812,896	3/1989	Rothgery et al.	357	70	· · · · · · · · · · · · · · · · · · ·
	5,157,480	10/1992	McShane et al.	361	404	
	5,200,362	4/1993	Lin et al.	437	207	
	5,200,809	4/1993	Kwon	257	707	
	5,214,845	6/1993	King et al.	29	841	·
	5,216,278	6/1993	Lin et al.	257	688	•
	5,221,642	6/1993	Burns	437	207	
-	5,273,938	12/1993	Lin et al.	437	207	
	5,277,972	1/1994	Sakumoto et al.	428	355	
	5,279,029	1/1994	Burns	29	856	
	5,332,864	7/1994	Liang et al.	174	52.4	
	5,343,076	8/1994	Katayama et al.	257	717	
	5,406,124	4/1995	Morita et al.	257	783	
	5,424,576	6/1995	Djennas et al.	257	666	
	5,457,340	10/1995	Templeton, Jr. et al.	257	666	
	5,474,958	12/1995	Djennas et al.	437	211	
-	5,604,376	2/1997	Hamburgen et al.	257	676	
	5,608,267	3/1997	Mahulikar et al.	257	796	
	5,639,990	6/1997	Nishihara et al.	174	52.2	
	5,640,047	6/1997	Nakashima	257	738	0)
	5,641,997	6/1997	Ohta et al.	257	788	
	5,646,831	7/1997	Manteghi	361	813	
	5,650,663	7/1997	Parthasarathi	257	706	
	5,683,806	11/1997	Sakumoto et al.	428	343	
	5,696,666	12/1997	Miles et al.	361 .	764	
	5,701,034	12/1997	Marrs	257	706	
	5,710,064	1/1998	Song et al.	437	220	
	5,710,695	1/1998	Manteghi	361	813	
	5,894,108	4/1999	Mostafazadeh et al.	174	52.4	
	5,976,912	11/1999	Fukutomi et al.	438	110	
	6,001,671	12/1999	Fjelstad	438	112	

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TRADENME	6,229,200	5/2001_	Mclellan et al.	257	666	
	6,498,099	12/2002	McLellan et al.	438	689	

### **FOREIGN PATENT DOCUMENTS**

	DOCUMENT NO.	DATE	COUNTRY	CLASS	SUBCL.	TRANSLATION	
	JP 59-208756	11/1984		*		YES	NO
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	NTS (Including Author.	Title, Date, Pertiner	nt Pages, Etc.)	·			×
OTHER DOCUMI						•	
OTHER DOCUMI							

<sup>\*</sup>EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if in conformance and not considered. Include copy of this form with next communication with applicant.